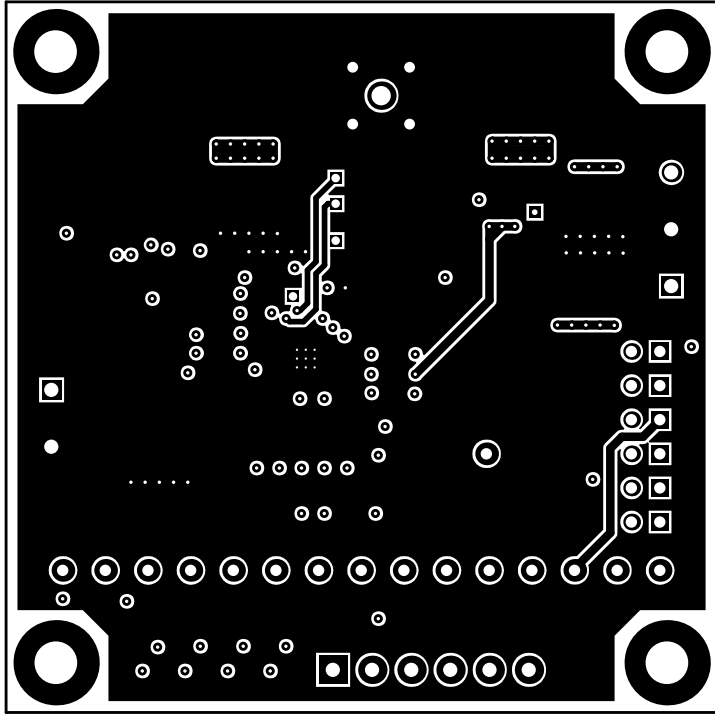
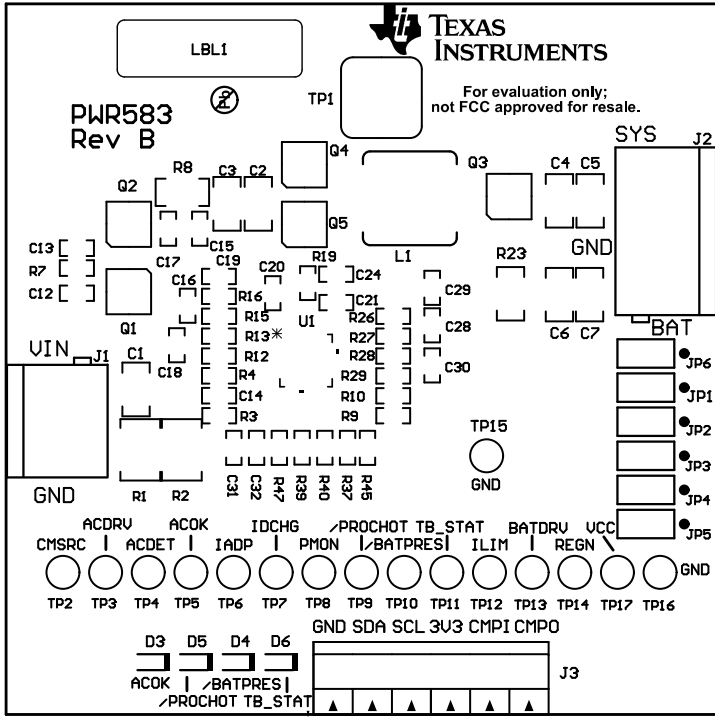


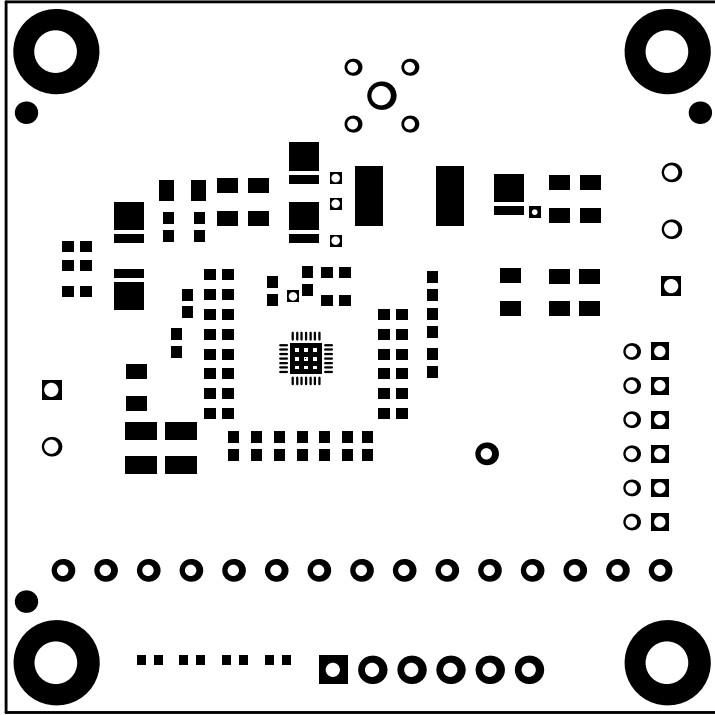
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR583	REV: B	SUN REV:
LAYER NAME = BoardOutline BoardOutline			
PLOT NAME =	GENERATED : 07/08/2014	TEXAS INSTRUMENTS	



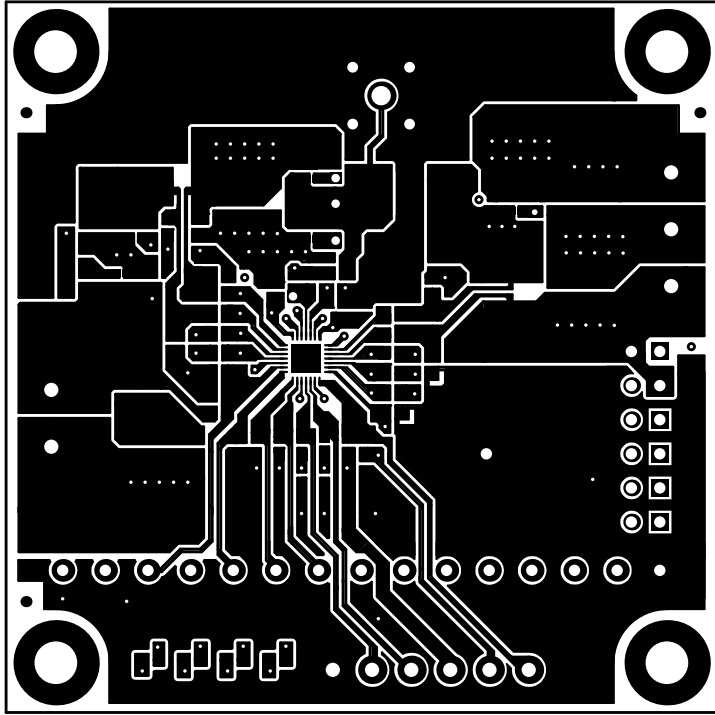
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR583	REV: B	SUN REV:
LAYER NAME = Board Outline			
PLOT NAME =	GENERATED : 07/08/2014	TEXAS INSTRUMENTS	



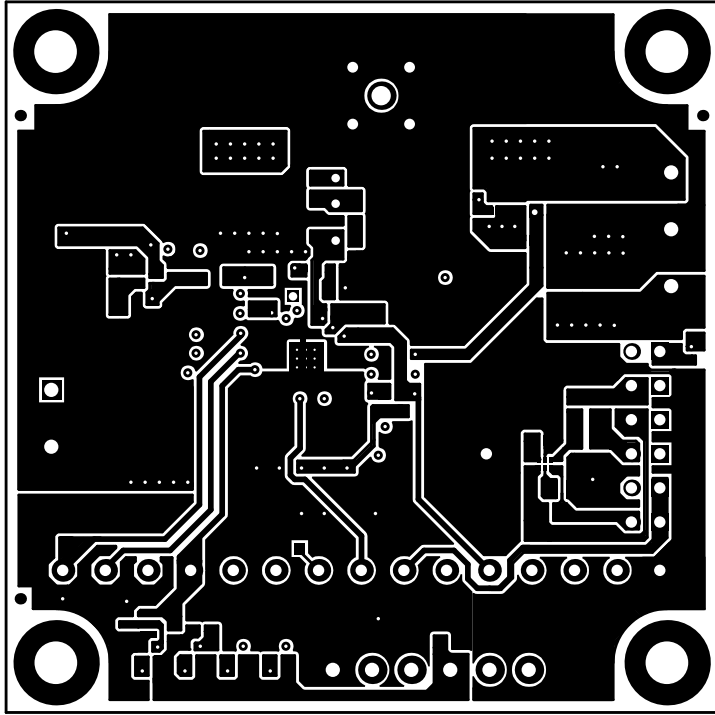
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR583	REV: B	SUN REV:
LAYER NAME = Top Overlay			
PLOT NAME =	GENERATED : 07/08/2014	TEXAS INSTRUMENTS	



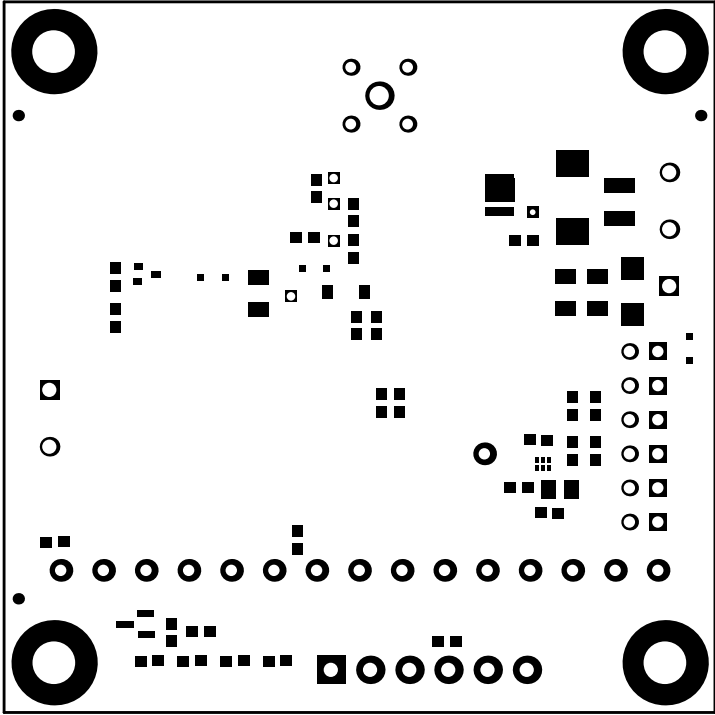
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR583	REV: B	SUN REV:
LAYER NAME = Top Solder			
PLOT NAME =	GENERATED : 07/08/2014	TEXAS INSTRUMENTS	



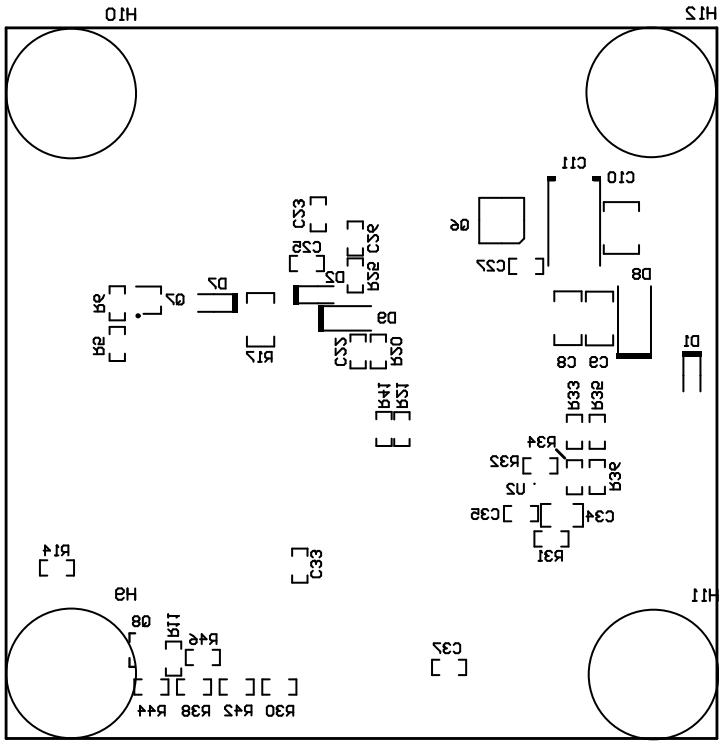
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR583	REV: B	SUN REV:
LAYER NAME = Top Layer			
PLOT NAME =	GENERATED : 07/08/2014	TEXAS INSTRUMENTS	



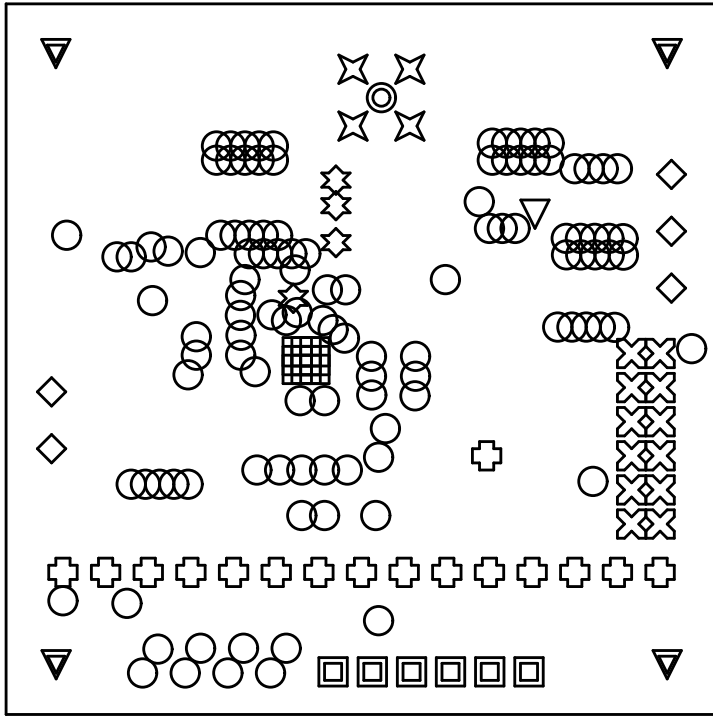
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR583	REV: B	SUN REV:
LAYER NAME = Bottom Layer			
PLOT NAME =	GENERATED : 07/08/2014	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR583	REV: B	SUN REV:
LAYER NAME = Bottom Solder			
PLOT NAME =	GENERATED : 07/08/2014	TEXAS INSTRUMENTS	

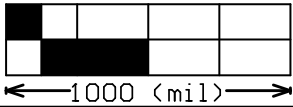
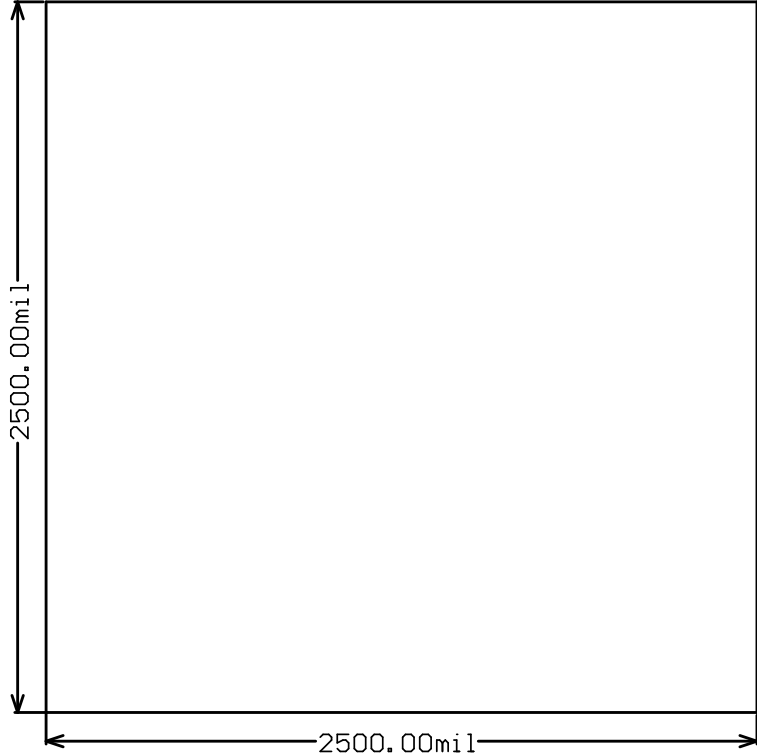


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR583	REV: B	SUN REV:
LAYER NAME = Bottom Overlay			
PLOT NAME =	GENERATED : 07/08/2014	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
□	9	7.87mil (0.200mm)	PTH	Round
○	115	12.00mil (0.305mm)	PTH	Round
▽	1	20.00mil (0.508mm)	PTH	Round
☆	4	30.00mil (0.762mm)	PTH	Round
⊗	4	38.00mil (0.965mm)	PTH	Round
⊕	16	40.00mil (1.016mm)	PTH	Round
⊗	12	40.16mil (1.020mm)	PTH	Round
◇	5	49.21mil (1.250mm)	PTH	Round
■	6	50.00mil (1.270mm)	PTH	Round
●	1	68.00mil (1.727mm)	PTH	Round
▽	4	150.00mil (3.810mm)	PTH	Round
	177 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR583	REV: B	SUN REV:
LAYER NAME = Drill Drawing			
PLOT NAME =	GENERATED : 07/08/2014	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PWR583	REV: B	SUN REV:
LAYER NAME = Board Dimensions			
PLOT NAME =	GENERATED : 07/08/2014	TEXAS INSTRUMENTS	

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